

World Components Network Service Ltd**Customer Name:****Date:**

2018-4-13

Part No:

WCN2S-1020B7-A1

**Product Group
Description:**

LED Display

Customer Part No:**Approval Date:****Customer
Confirmation****Approved by****Checked by**Athena
2018-4-13**Prepared By**Fei
2018-4-13

Country of Origin: China

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REVISION RECORD

MARKER	Matter for revision	SHEET	DTAE	MAKER	APPOVED SIGN	
	Reason for revision					
A0	<p style="text-align: center;">P# WCN2S-1020B7-A1</p> <hr style="border-top: 1px dashed black;"/> <p style="text-align: center;">New Version issued</p>	Whole Spec	2018-4-13	Zhang	Athena	

1. Type No./Manufacture's Name

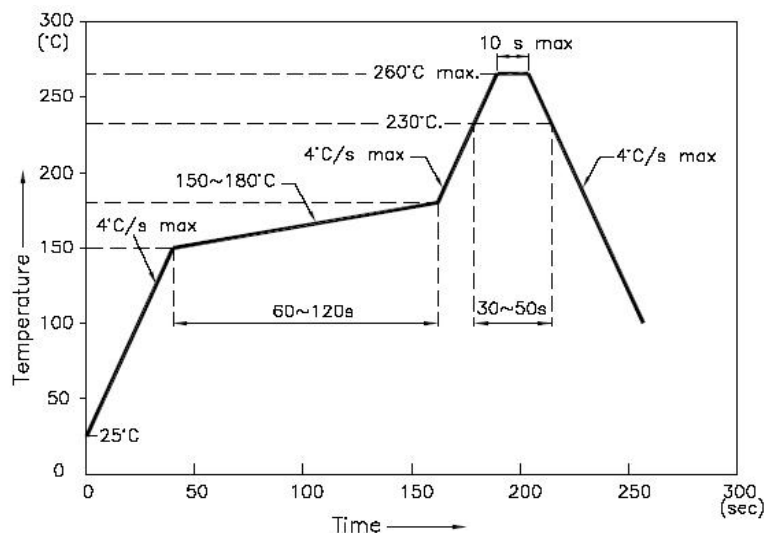
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2. Features:

- . High Reliability
- . Low Power Requirement
- . Easy Assembly

3. Faction: Display Digit Characteristic**4. Soldering Conditions: Soldering Temp. 260 ± 5 °C, Soldering Time. 3~5 sec.**

Soldering Power <30 W.

5. Re-flow Temp/Time**NOTES:**

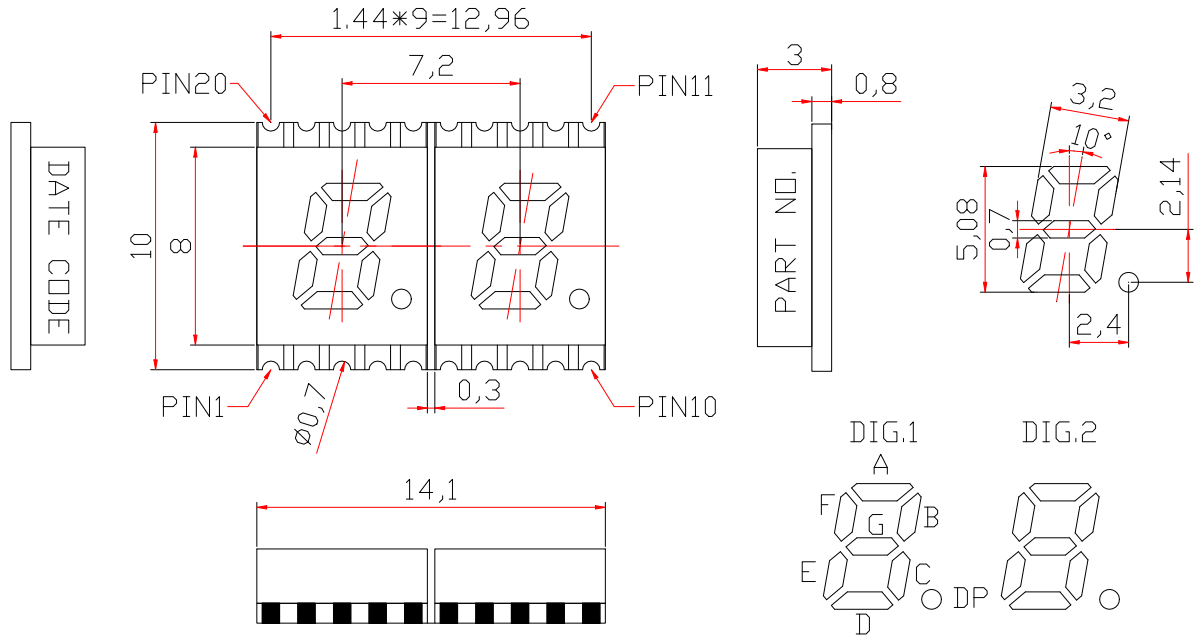
5.1. We recommend the re-flow temperature $245^{\circ}\text{C}(\pm 5^{\circ}\text{C})$. the maximum soldering temperature should be limited to 260°C .

5.2. Don't cause stress to the epoxy resin while it is exposed to high temperature. Number of re-flow process shall be 2 times or less.

6. Description:

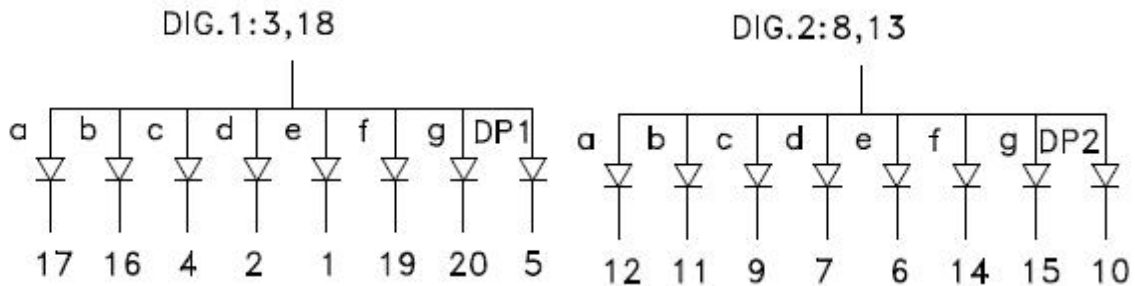
- . Two Digit LED Display
- . Digit Height: 5.08mm(0.20")
- . Gray Face and Milky Segment
- . Color: Blue

Outer Dimension:



Notes: Unless otherwise stated, the tolerance is $\pm 0.25\text{mm}$.

Circuit Diagram:



Pin Connection:

PIN NO.	CONNECTION	PIN NO.	CONNECTION
1	Cathode E1	11	Cathode B2
2	Cathode D1	12	Cathode A2
3	Common Anode dig1	13	Common Anode dig2
4	Cathode C1	14	Cathode F2
5	Cathode DP1	15	Cathode G2
6	Cathode E2	16	Cathode B1
7	Cathode D2	17	Cathode A1
8	Common Anode dig2	18	Common Anode dig1
9	Cathode C2	19	Cathode F1
10	Cathode dp2	20	Cathode G1

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■ ABSOLUTE MAXIMUM RATINGS AT TA=25°C

Parameter	Symbol	Condition	Color	Rating	Units
Power Dissipation Per Segment	P_d	—	Blue	90	mW
Forward Current Per Segment	I_F	—	Blue	25	mA
Peak Forward Current Per Segment	I_{FP}	1/10 Duty 1KHz	Blue	100	mA
Reverse Voltage Per Segment	V_R	—	Blue	5	V
Operating Temperature Range	T_{opr}	—	—	-40~+105	°C
Storage Temperature Range	T_{stg}	—	—	-40~+105	°C

■ Electrical/Optical Characteristics Rating(Ta=25°C)

Item	Symbol	Test conditions	Location	Rating			Units
				Min.	Typ.	Max.	
Forward Voltage	V_F	$I_F=20mA$	Per Chip	2.6	3.2	3.6	V
Reverse Current	I_R	$V_R=5V$	Per Chip	—	—	100	μA
Luminous Intensity	I_V	$I_F=10mA$	Per Chip	3051	5500	8500	μcd
Wave Length	λ_D			—	465	—	
Spectral Line Half Width	$\Delta \lambda$	$I_F=20mA$	Per Chip	—	—	20	nm
Luminous Intensity Matching Ratio (Segment To Segment)	I_{v-m}	$I_F=10mA$				1.2:1	

■ Luminous Intensity Sorting: (Luminous intensity tolerance :+/-10%)

Rank	Symbol	Condition	Min	Max	Unit
K	K	$I_F=10mA$	3051	4000	μcd
L	L	$I_F=10mA$	4001	5000	μcd
M	M	$I_F=10mA$	5001	6100	μcd
N	N	$I_F=10mA$	6101	7200	μcd
O	O	$I_F=10mA$	7201	8500	μcd

■ **Typical Optical-Electronic Characteristic Curves**

Fig1. Forward Current vs. Forward Voltage:

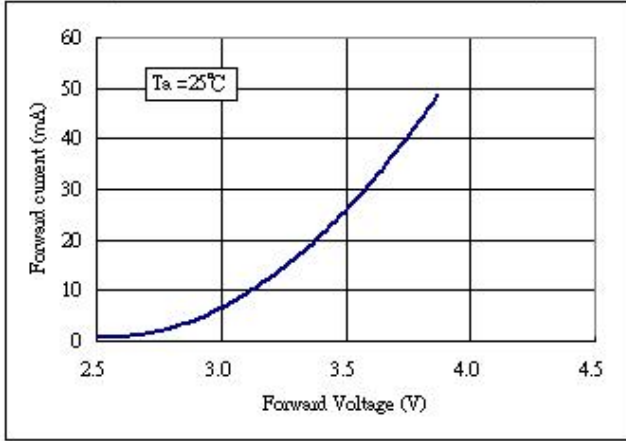


Fig2. Forward Current vs. Relative Intensity:

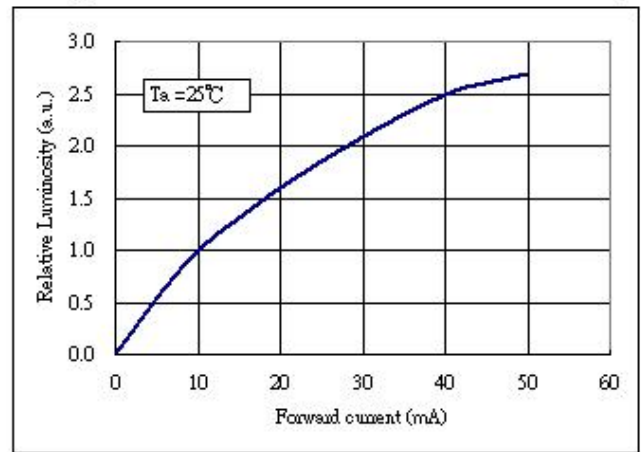


Fig3. Forward Current vs. Relative Wavelength:

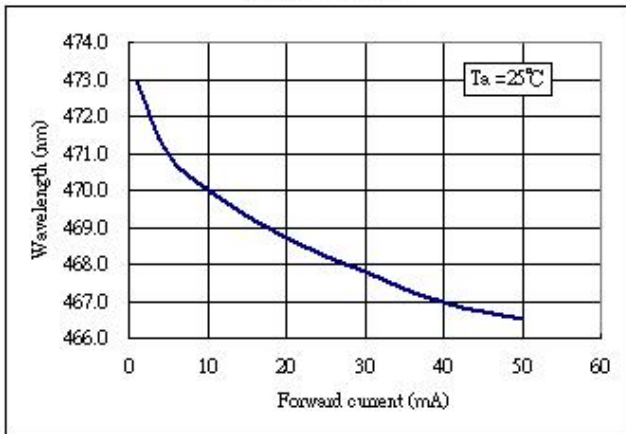
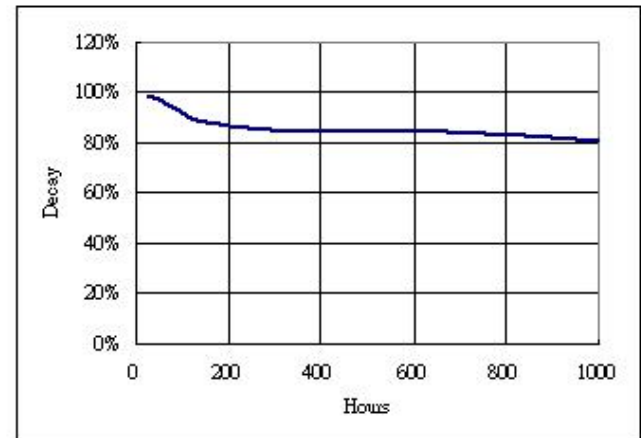
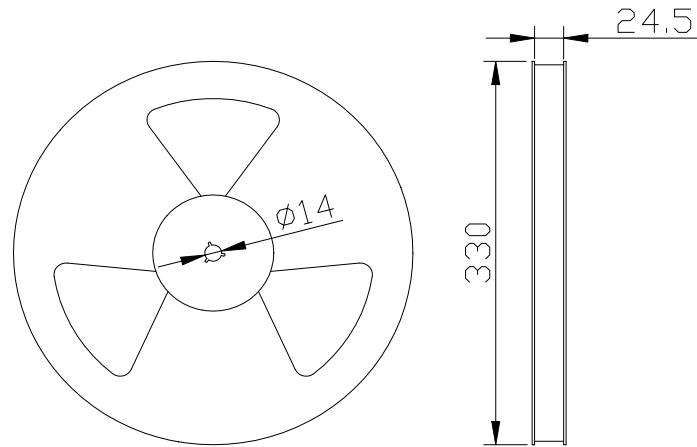


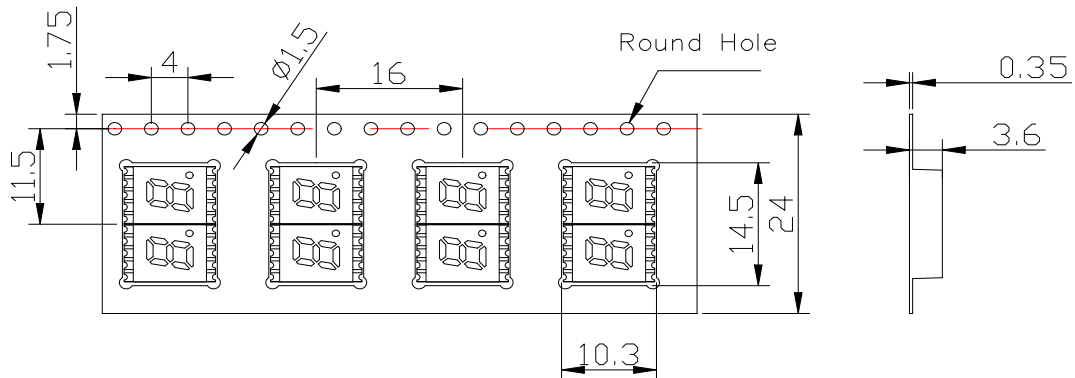
Fig4. Life Test at 20mA R.T. 1000hrs:



■ Packing Reel Dimensions(mm):

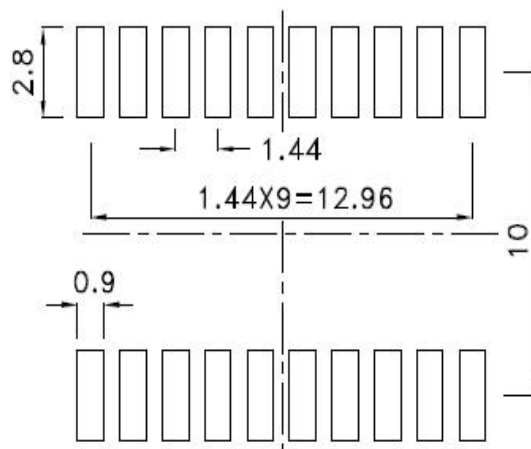


■ Dimensions of Tape (Unit: mm)



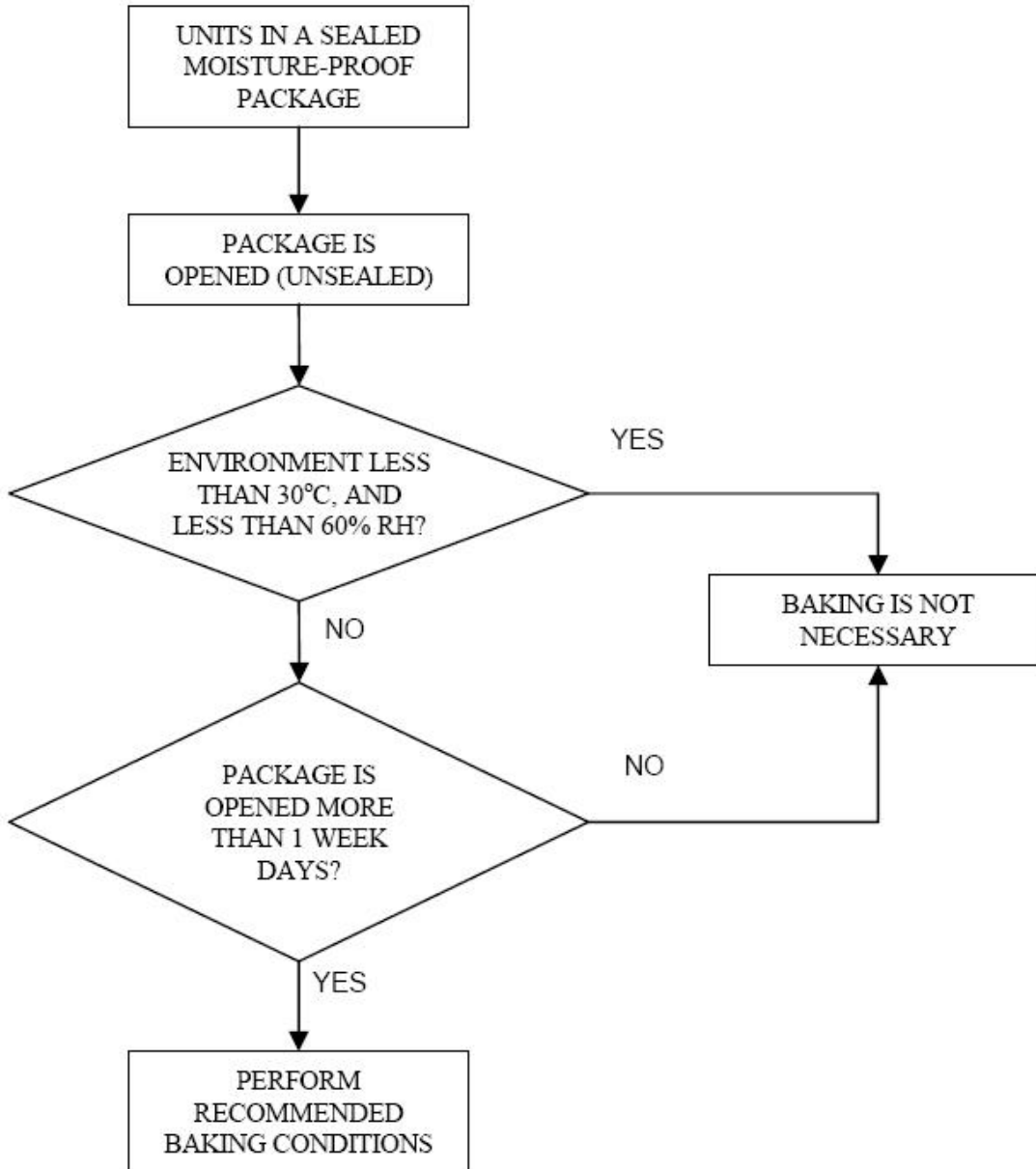
■ One Reel contained 1100 PCS products:

■ Recommended Soldering Pattern:



■ **Moisture Proof Packaging:**

All N/D SMD displays are shipped in moisture proof package. The displays should be stored at 30°C or less and 60% RH or less. Once the package opened, moisture absorption begins.



■ **Baking Conditions:**

If the parts not stored in dry conditions, they must be baked before re-flow to prevent damage to the parts.

Package	Temperature	Time
In Reel	60 °C	≥ 48hours
In Bulk	100 °C	≥ 4hours
	125 °C	≥ 2hours

■ **Baking should only be done once.**